LGA Package
21-Lead (6.25mm × 6.25mm × 2.32mm)
(Reference LTC DWG # 05-08-1803 Rev B)

NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
2. ALL DIMENSIONS ARE IN MILLIMETERS
3. LAND DESIGNATION PER JESD MO-222, SPP-010 AND SPP-020
4. DETAILS OF PAD #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE PAD #1 IDENTIFIER MAY BE EITHER A MOLD OR A MARKED FEATURE
5. PRIMARY DATUM -Z- IS SEATING PLANE
6. THE TOTAL NUMBER OF PADS: 21
7. PACKAGE ROW AND COLUMN LABELING MAY VARY AMONG µModule PRODUCTS. REVIEW EACH PACKAGE LAYOUT CAREFULLY

SYMBOL TOLERANCE
aaa 0.15
bbb 0.10

PACKAGE TOP VIEW

PACKAGE SIDE VIEW

DETAIL A

SUBSTRATE
MOLD CAP

PACKAGE IN TRAY LOADING ORIENTATION

SUGGESTED PCB LAYOUT

TOP VIEW

BOTTOM VIEW

PACKAGE LOADING ORIENTATION

TRAY PIN 1 BEVEL

COMPONENT PIN "A1"